CMOS MSI

Quad R-S Latches

The MC14043B and MC14044B quad R-S latches are constructed with MOS P-channel and N-channel enhancement mode devices in a single monolithic structure. Each latch has an independent Q output and set and reset inputs. The Q outputs are gated through three-state buffers having a common enable input. The outputs are enabled with a logical "1" or high on the enable input; a logical "0" or low disconnects the latch from the Q outputs, resulting in an open circuit at the Q outputs.

- **Double Diode Input Protection**
- Three-State Outputs with Common Enable
- Outputs Capable of Driving Two Low-power TTL Loads or One Low-Power Schottky TTL Load Over the Rated Temperature Range
- Supply Voltage Range = 3.0 Vdc to 18 Vdc

MC14043B MC14044B



L SUFFIX CERAMIC CASE 620



P SUFFIX PLASTIC CASE 648

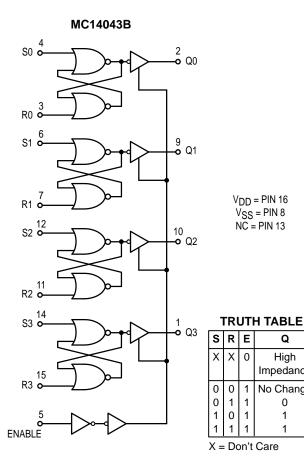


D SUFFIX SOIC CASE 751B

ORDERING INFORMATION

MC14XXXBCP Plastic MC14XXXBCL Ceramic MC14XXXBD SOIC

 $T_{\Delta} = -55^{\circ}$ to 125°C for all packages.



Impedance No Change

V_{DD} = PIN 16

V_{SS} = PIN 8

NC = PIN 13

Ε

High

0

1

Χ 0

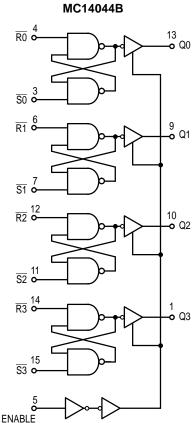
0

1 1

0

1

1



V_{DD} = PIN 16 V_{SS} = PIN 8 NC = PIN 2

TRUTH TABLE

S	R	Ε	Q
Χ	Χ	0	High
			Impedance
0	0	1	0
0	1	1	1
1	0	1	0
1	1	1	No Change

X = Don't Care



ELECTRICAL CHARACTERISTICS (Vottages Referenced to V_{SS})

		V _{DD}	- 55	5°C		25°C		125	°C	
Characteristic	Symbol	Vdc	Min	Max	Min	Тур#	Max	Min	Max	Unit
Output Voltage "0" Level Vin = VDD or 0	V _{OL}	5.0 10 15		0.05 0.05 0.05	_ _ _	0 0 0	0.05 0.05 0.05		0.05 0.05 0.05	Vdc
v_{in} = 0 or v_{DD}	Voн	5.0 10 15	4.95 9.95 14.95		4.95 9.95 14.95	5.0 10 15	- -	4.95 9.95 14.95	_	Vdc
Input Voltage "0" Level (VD = 4.5 or 0.5 Vdc) (VD = 9.0 or 1.0 Vdc) (VD = 13.5 or 1.5 Vdc)	VIL	5.0 10 1 5		1.5 3.0 4.0		2.25 4.50 6.75	1.5 3.0 4.0		1.5 3.0 4.0	Vdc
"1" Level (VD = 0.5 or 4.5 Vdc) (VD = 1.0 or 9.0 Vdc) (VD = 1.5 or 13.5 Vdc)	∨н	5.0 10 15	3.5 7.0 11		3.5 7.0 11	2.75 5.50 8.25		3.5 7.0 11	1 1 1	Vdc
Output Drive Current (VOH = 2.5 Vdc) Source (VOH = 4.6 Vdc) (VOH = 9.5 Vdc) (VOH = 13.5 Vdc)	ЮН	5.0 5.0 10 15	- 3.0 - 0.64 - 1.6 - 4.2		- 2.4 - 0.51 - 1.3 - 3.4	- 4.2 - 0.88 - 2.25 - 8.8		1.7 0.36 0.9 2.4	I I I I	mAdc
$(V_{OL} = 0.4 \text{ Vdo})$ Sink $(V_{OL} = 0.5 \text{ Vdc})$ $(V_{OL} = 1.5 \text{ Vdc})$	loL	5.0 10 15	0.64 1.6 4.2	_	0.51 1.3 3.4	0.88 2.25 8.8	<u>-</u> -	0.36 0.9 2.4		mAdc
Input Current	lin	15		± 0.1		±0.00001	± 0.1		± 1.0	μAdc
Input Capacitance (V _{in} = 0)	C _{in}			! <u></u>		5.0	7.5		_	pF
Quiescent Current (Per Package)	IDD	5.0 10 15		1.0 2.0 4.0	_ 	0.002 0.004 0.006	1.0 2.0 4.0	-	30 60 120	μAdc
Total Supply Current**† (Dynamic plus Quiescent, Per Package) (CL = 50 pF on all outputs all buffers switching)	¹T	5.0 10 15			$1_{T} = (1$.58 μΑ/kHz) .15 μΑ/kHz) .73 μΑ/kHz)	f + I _{DD}			μAdc
Three-State Output Leakage Current	lTL	15	-	± 0.1	_	± 0.0001	± 0.1		± 3.0	μAdc

#Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential Performance.

$$i_T(C_L) = iT(50 pF) + (CL - 50) Vfk$$

where: IT is in μA (per package), CL in pF, V = (VDD - VSS) in volts, f in kHz is input frequency, and k = 0.004.

[&]quot;The formulas given are for the typical characteristics only at 25°C.

[†]To calculate total supply current at loads other than 50 pF:

[•] Maximum Ratings are those values beyond which damage to the device may occur.

[†]Temperature Derating: Plastic "P and D/DW" Packages: - 7.0 mW/°C From 65°C To 125°C Ceramic "L" Packages - 12 mW/°C From 100°C To 125°C

MAXIMUM RATINGS* (Voltages Referenced to VSS)

Symbol	Parameter	Value	Unit
V _{DD}	DC Supply Voltage	- 0.5 to + 18.0	٧
V _{in} , V _{out}	Input or Output Voltage (DC or Transient)	- 0.5 to V _{DD} + 0.5	V
l _{in} , l _{out}	Input or Output Current (DC or Transient), per Pin	± 10	mA
P_{D}	Power Dissipation, per Package†	500	mW
Tstg	Storage Temperature	- 65 to + 150	°C
ΤL	Lead Temperature (8-Second Soldering)	260	°C

^{*} Maximum Ratings are those values beyond which darnage to the device may occur. †Temperature Derating:

Ceramic "L" Packages: - 12 mW/°C From 100°C To 125°C

Plastic "P and D/DW" Packages: - 7.0 mW/°C From 65°C To 125°C

SWITCHING CHARACTERISTICS* (CL = 50 pF, TA = 25°C)

This device contains protection circuitry to guard against darnage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper Operation, V_{in} and V_{out} should be constrained to the range V_{SS} ≤ (V_{in} or V_{out}) ≤ VDD.

Unused inputs must always be tied to an

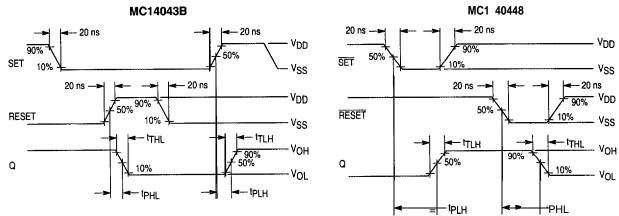
appropriate logic voltage level (e.g., either VSS or VDD). Unused Outputs must be left open.

Characteristic	Symbol	VDD Vdc	Min	Typ#	Max	Unit
Output Rise Time $t_{TLH} = (1.35 \text{ ns/pF}) C_L + 32.5 \text{ ns}$ $t_{TLH} = (0.60 \text{ ns/pF}) C_L + 20 \text{ ns}$ $t_{TLH} = (0.40 \text{ ns/pF}) C_L + 20 \text{ ns}$	⁴т∟н	5.0 10 15		100 50 40	200 100 80	ns
Output Fall Time t _{THL} = (1.35 ns/pF) C _L + 32.5 ns t _{THL} = (0.60 ns/pF) C _L + 20 ns t _{THL} = (0.40 ns/pF) C _L + 20 ns	ţтнL	5.0 10 15	-	100 50 40	200 100 80	ns
Propagation Delay Time tpLH = (0.90 ns/pF) C _L + 130 ns tpLH = (0.36 ns/pF) C _L + 57 ns tpLH = (0.26 ns/pF) C _L + 47 ns	†PLH	5.0 10 15		175 75 60	350 175 120	ns
tpHL = (0.90 ns/pF) CL + 130 ns tpHL = (0.90 ns/pF) CL + 57 ns tpHL = (0.26 ns/pF) CL + 47 ns	†PHL	5.0 10 15	=	175 75 60	350 175 120	ns
Set, Set Pulse Width	tW	5.0 10 15	200 100 70	60 40 30		ns
Reset, Reset Pulse Width	tw	5.0 10 15	200 100 70	80 40 30		ns
Three-State Enable/Disable Delay	tplz, tpHz, tpZL, tPZH	5.0 10 15	=	150 80 55	300 160 110	ns

^{*} The formulas given are for the typical characteristics only at 25°C.

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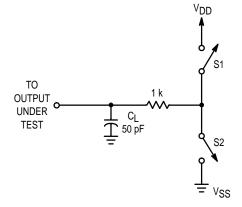
AC WAVEFORMS

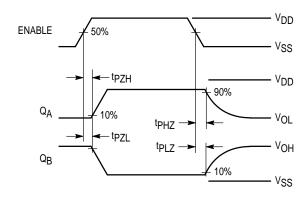


THREE-STATE ENABLE/DISABLE DELAYS

Set, Reset, Enable, and Switch Conditions for 3-State Tests

					MC14043B		MC14044B	
Test	Enable	S1	S2	Q	S	R	S	R
^t PZH		Open	Closed	Α	V_{DD}	VSS	VSS	V_{DD}
t _{PZL}		Closed	Open	В	VSS	V_{DD}	V_{DD}	VSS
t _{PHZ}	~	Open	Closed	Α	V_{DD}	VSS	VSS	V_{DD}
t _{PLZ}	~	Closed	Open	В	Vss	V_{DD}	V_{DD}	VSS





PIN ASSIGNMENT

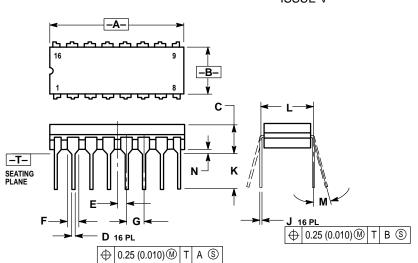
MC14043B							
Q3 [1 ●	16] V _{DD}				
Q0 [2	15] R3				
R0 [3	14] S3				
S0 [4	13] NC				
ΕQ	5	12] S2				
S1 [6	11] R2				
R1 [7	10] Q2				
V _{SS} [8	9] Q1				

MC14044B							
Q3	1 •		V _{DD}				
NC	2	15] S 3				
S0	3	14] R3				
R0	4	13] Q0				
E	5	12	R2				
R1	6	11] <u>S2</u>				
S1	7	10	Q2				
VSS	8	9	Q1				

NC = NO CONNECTION

OUTLINE DIMENSIONS



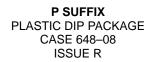


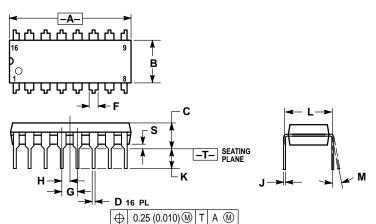
NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

- ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
 DIMENSION L TO CENTER OF LEAD WHEN
 FORMED PARALLEL.
 DIMENSION F MAY NARROW TO 0.76 (0.030)
 WHERE THE LEAD ENTERS THE CERAMIC

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
Е	0.050 BSC		1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300 BSC		7.62 BSC		
М	0°	15°	0 °	15°	
N	0.020	0.040	0.51	1.01	





NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: INCH.

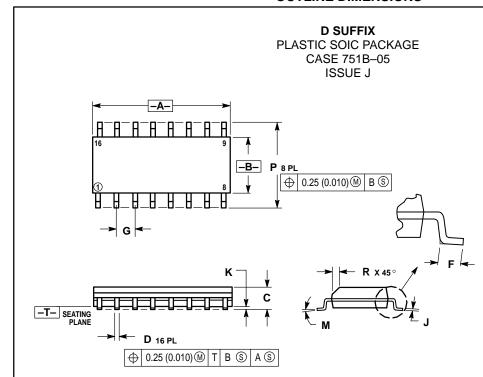
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.

 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
M	0°	10°	0°	10 °	
S	0.020	0.040	0.51	1.01	

OUTLINE DIMENSIONS



- DIMENSIONING AND TOLERANCING PER ANSI
- CONTROLLING DIMENSION: MILLIMETER.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.

 MAXIMUM MOLD PROTRUSION 0.15 (0.006)
- PER SIDE.
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR
 PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	9.80	10.00	0.386	0.393	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27	BSC	0.050 BSC		
Ĺ	0.19	0.25	0.008	0.009	
Κ	0.10	0.25	0.004	0.009	
М	0°	7°	0°	7°	
Р	5.80	6.20	0.229	0.244	
R	0.25	0.50	0.010	0.019	

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